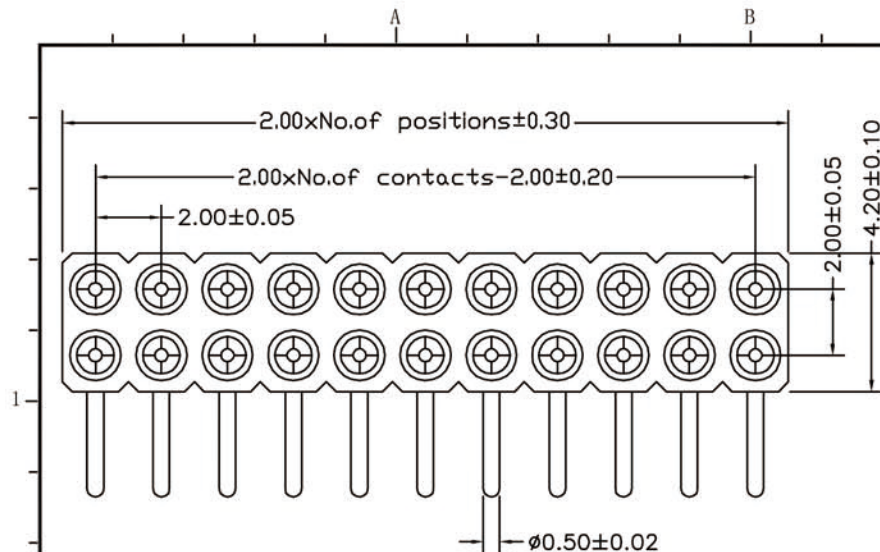
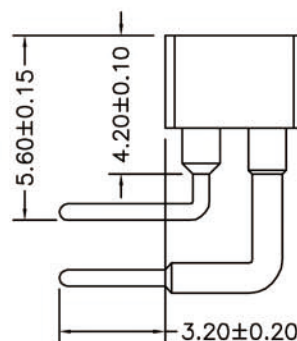


P. C. B LAYOUT



Technical Data

Material:

Pin(outer sleeve):Brass,machined CuZn38Pb2

Plating(outer sleeve):

Tin Plated:2 μ m/80 μ m"NI, 5 μ m/200 μ "Sn

Gold Plated:2 μ m"/80 μ m"Ni, 0.8 μ " gold

Plating(Contact):2 μ m/80 μ "NI,gold or Tin plated

Insulator:PPS UL94V-0

Clip(Contact 4 Flinger):Beryllium copper,heat teated

Mating pin□:0.40mm/0.66mm

Electrical:

Current rating:3Amps/contact max.

Contact resistance:≤4m Ω /contact

Insulation resistance:≥1000M Ω at V=100V

Dlelectric Withstanding Voltage:1000V AV Min

Operaling voltage:60VAC/DC

Mechanical:

-Insertion:0.7N typ

-Withdrawal:0.4N typ

Mechanical lige:min 500 cycle

Operaling temperature:-40° C to+105° C

Soldering temperature:+255° C

TOLERANCE:

.X. ±XXX

.X ±0.20

.XX ±0.10

ANG.



產品名稱:

產品料號:

上海狮拓电子科技有限公司

THIRD ANGLE PROJECTION



簽名 _____

日期 _____

審核 _____

日期 _____

客戶確認

☐ 承認 _____ 日期 _____

☐ 駁回 _____ 日期 _____

STOC2-RXXXXXX1360B